SunLED
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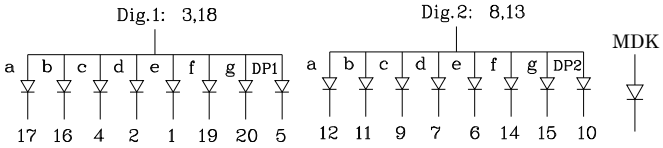
Part Number: ZFMDK10A2

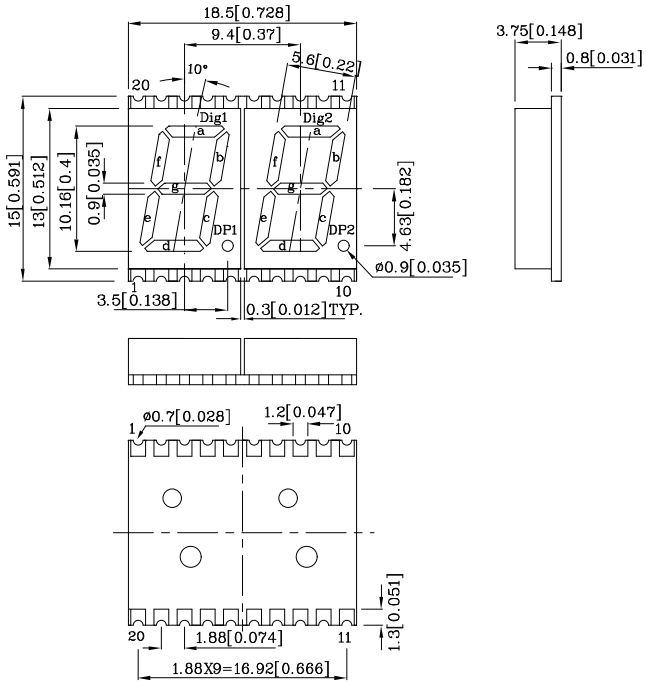
SURFACE MOUNT DISPLAY

Features

- 0.4INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- GRAY FACE,WHITE SEGMENT.
- PACKAGE:250PCS/REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.







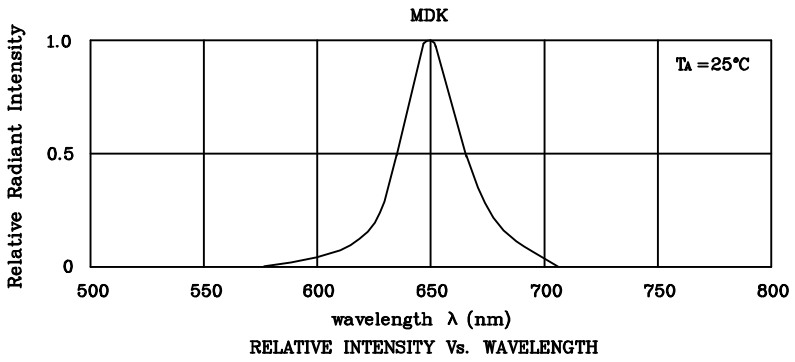
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25(0.01") unless otherwise noted.
3. Specifications are subject to change without notice.
4. The gap between the reflector and PCB shall not exceed 0.25mm.

Absolute Maximum Ratings (TA=25°C)		**MDK (InGaAlP)**	**Unit**
Reverse Voltage	V_R	5	V
Forward Current	I_F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	185	mA
Power Dissipation	P_T	75	mW
Operating Temperature	T_A	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +85	

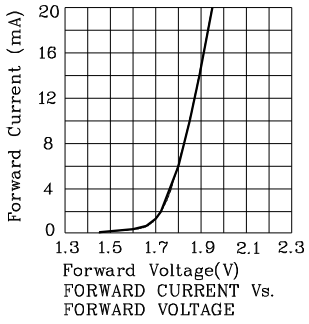
Operating Characteristics (T_A=25°C)		**MDK (InGaAlP)**	**Unit**
Forward Voltage (Typ.) (I_F=10mA)	V_F	1.85	V
Forward Voltage (Max.) (I_F=10mA)	V_F	2.5	V
Reverse Current (Max.) (V_R=5V)	I_R	10	uA
Wavelength of Peak Emission (Typ.) (I_F=10mA)	λ P	650	nm
Wavelength of Dominant Emission (Typ.) (I_F=10mA)	λ D	635	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I_F=10mA)	Δλ	28	nm
Capacitance (Typ.) (V_F=0V, f=1MHz)	C	35	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA) ucd		Wavelength nm λ P	Description
			min.	typ.		
ZFMDK10A2	Red	InGaAlP	8000	25990	650	Common Anode. Rt. Hand Decimal

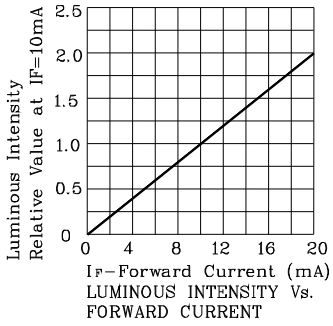


RELATIVE INTENSITY Vs. WAVELENGTH

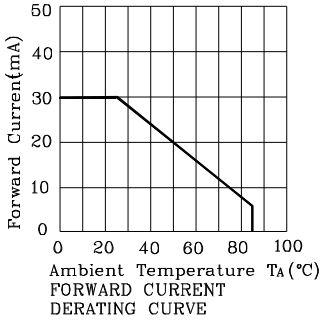
❖ MDK



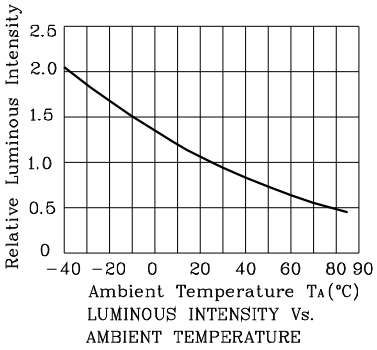
FORWARD CURRENT Vs.
FORWARD VOLTAGE



LUMINOUS INTENSITY Vs.
FORWARD CURRENT



FORWARD CURRENT
DERATING CURVE



LUMINOUS INTENSITY Vs.
AMBIENT TEMPERATURE

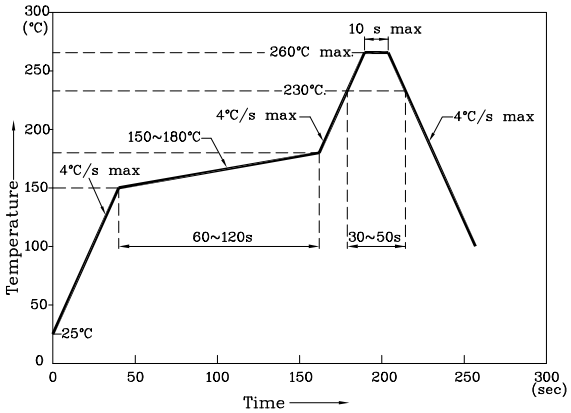
Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous intensity / luminous flux: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

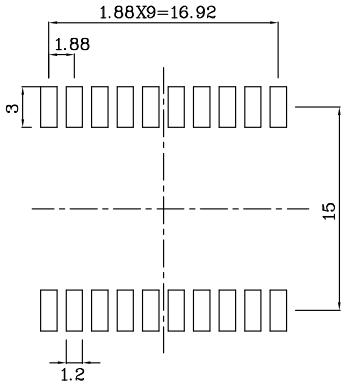
Reflow Soldering Profile For Lead-free SMT Process.



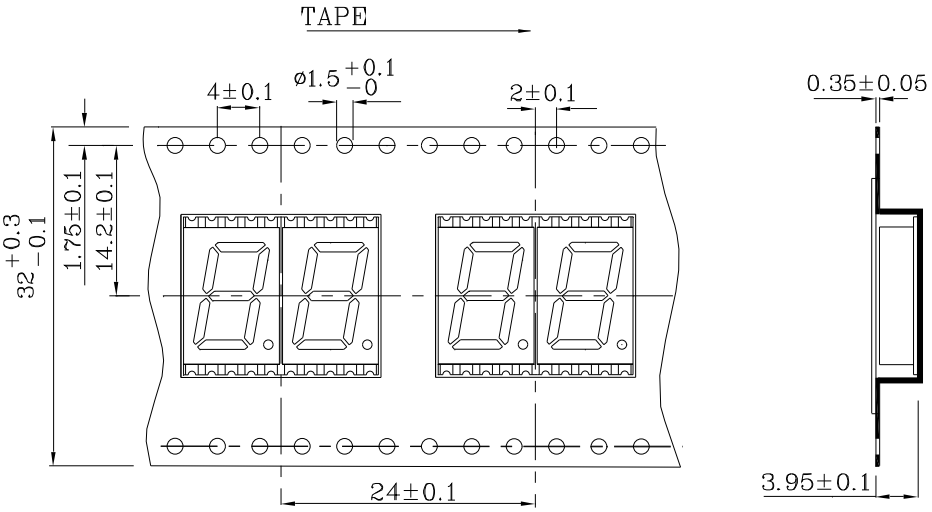
NOTES:

1. Maximum soldering temperature should not exceed 260°c.
2. Recommended reflow temperature: 145°c~260°c.
3. Do not put stress to the epoxy resin during high temperatures conditions.

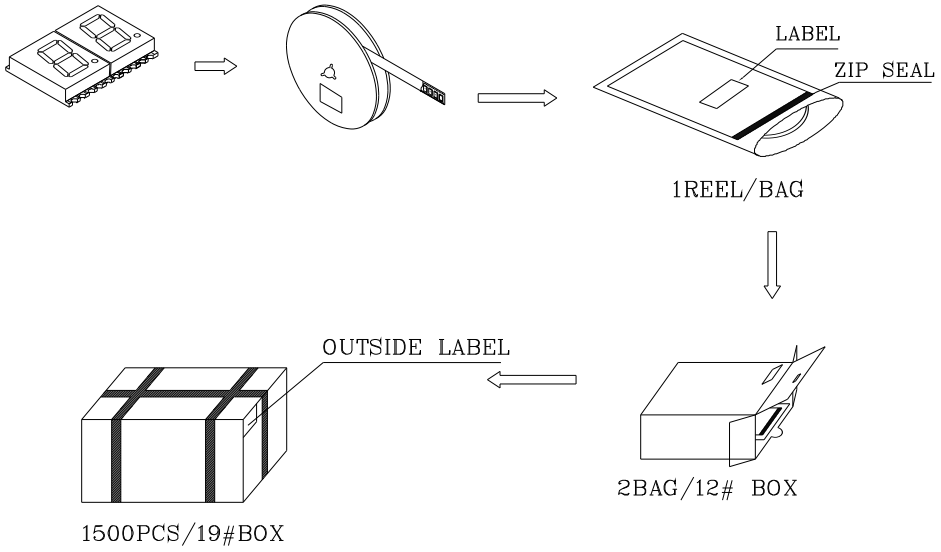
❖ Recommended Soldering Pattern (Units : mm; Tolerance: ±0.15)



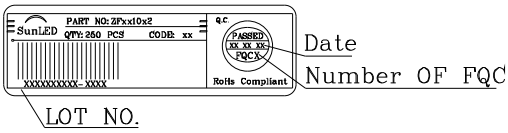
❖ Tape Specification (Units : mm)



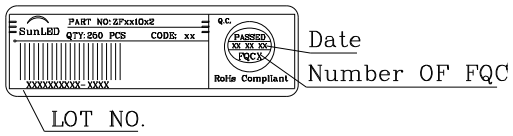
PACKING & LABEL SPECIFICATIONS ZFMDK10A2



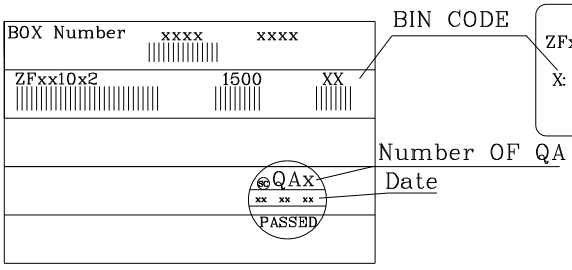
Inside LABEL Paste On The TAPE



Outside LABEL Paste On The BAG



Outside LABEL Paste On The 19#Box



Outside LABEL Paste On The 12#Box

